

## Product Summary

<b>V<sub>BR</sub> Min</b>	<b>I<sub>PP</sub> Max</b>	<b>C<sub>T</sub> Typ</b>
6.2V	70A	950pF

## Description

This new generation TVS is designed to protect sensitive electronics from the damage due to ESD. The combination of small size and high ESD surge capability makes it ideal for use in portable applications such as cellular phones, digital cameras, and MP3 players.

## Applications

- Cellular Handsets
- Portable Electronics
- Computers and Peripheral

## Features

- Provides ESD Protection Per IEC 61000-4-2 Standard: Air ±30kV, Contact ±30kV
- 1 Channel of ESD Protection
- Low Channel Input Capacitance
- **Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**

## Mechanical Data

- Case: SOD323
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Matte Tin Finish annealed over Alloy 42 leadframe (Lead Free Plating). Solderable per MIL-STD-202, Method 208
- Weight: 0.004 grams (Approximate)

SOD323



Top View



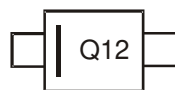
Device Schematic

## Ordering Information (Note 4)

Product	Compliance	Marking	Reel Size(inches)	Tape Width(mm)	Quantity Per Reel
D5V0S1U2WS-7	Standard	Q12	7	8	3,000/Tape & Reel

- Notes:
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
  2. See [http://www.diodes.com/quality/lead\\_free.html](http://www.diodes.com/quality/lead_free.html) for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
  3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
  4. For packaging details, go to our website at <http://www.diodes.com/products/packages.html>.

## Marking Information



Q12 = Product Type Marking Code  
Line Denotes Pin 1

**Maximum Ratings** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	Conditions
Peak Pulse Power Dissipation	P <sub>PP</sub>	1000	W	8/20μs, Per Figure 3
Peak Pulse Current	I <sub>PP</sub>	70	A	8/20μs, Per Figure 3
ESD Protection – Contact Discharge	V <sub>ESD_Contact</sub>	±30	kV	Standard IEC 61000-4-2
ESD Protection – Air Discharge	V <sub>ESD_Air</sub>	±30	kV	Standard IEC 61000-4-2

**Thermal Characteristics**

Characteristic	Symbol	Value	Unit
Package Power Dissipation (Note 5)	P <sub>D</sub>	350	mW
Thermal Resistance, Junction to Ambient (Note 5)	R <sub>θJA</sub>	500	°C/W
Operating Temperature Range	T <sub>J</sub>	-55 to +125	°C
Storage Temperature Range	T <sub>STG</sub>	-65 to +150	°C

**Electrical Characteristics** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Conditions
Reverse Working Voltage	V <sub>RWM</sub>	—	—	5.5	V	—
Reverse Current (Note 6)	I <sub>R</sub>	—	1	3	μA	V <sub>R</sub> = V <sub>RWM</sub> = 5V
Reverse Breakdown Voltage	V <sub>BR</sub>	6.2	—	7.4	V	I <sub>R</sub> = 1mA
Reverse Clamping Voltage	V <sub>CL</sub>	—	—	9	V	I <sub>PP</sub> = 5A, t <sub>p</sub> = 8/20μs
		—	—	12		I <sub>PP</sub> = 50A, t <sub>p</sub> = 8/20μs
		—	—	16		I <sub>PP</sub> = 70A, t <sub>p</sub> = 8/20μs
Capacitance	C <sub>T</sub>	—	950	—	pF	V <sub>R</sub> = 0V, f = 1MHz

- Notes:
- 5. Device mounted on FR-4 PCB pad layout (2oz copper) as shown on Diodes, Inc. suggested pad layout AP02001, which can be found on our website at <http://www.diodes.com>.
  - 6. Short duration pulse test used to minimize self-heating effect.

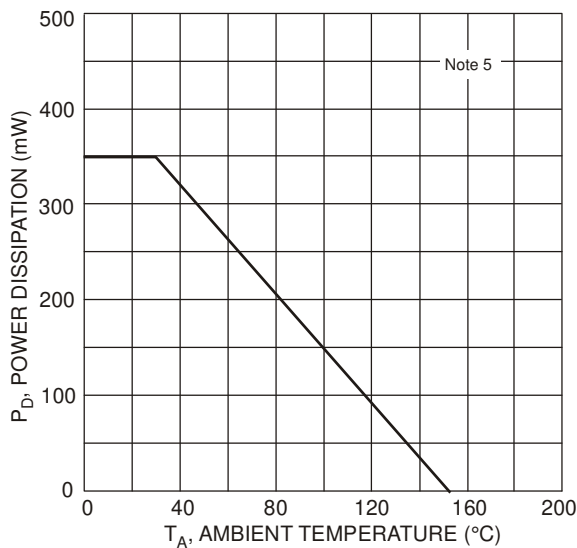


Figure 1 Power Derating Curve

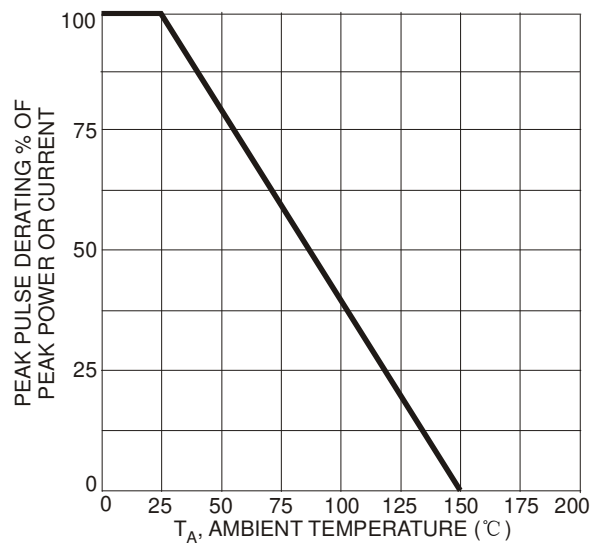


Figure 2 Pulse Derating Curve

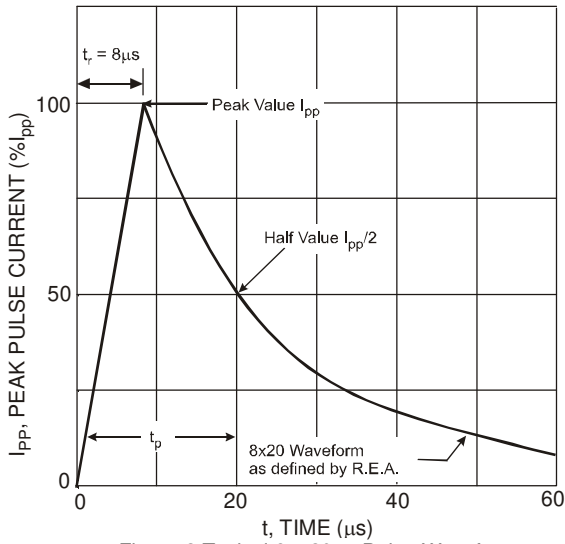


Figure 3 Typical 8 x 20 $\mu$ s Pulse Waveform

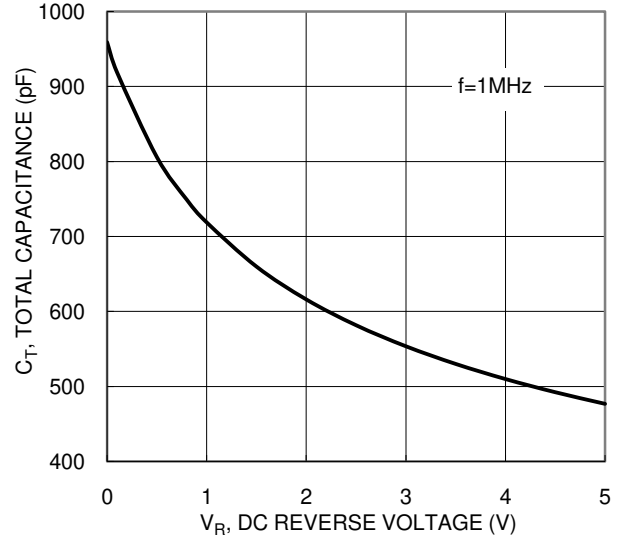
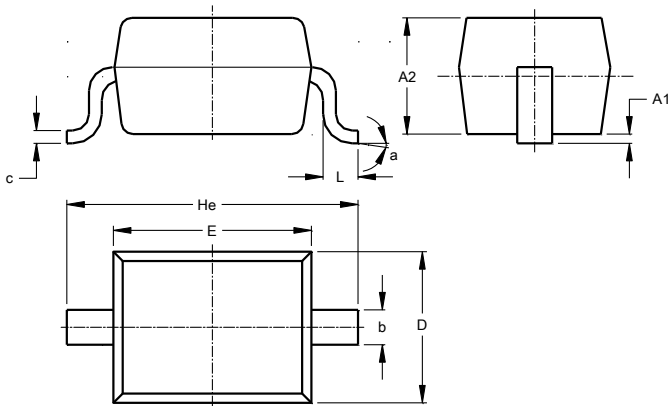


Figure 4 Total Capacitance vs. Reverse Voltage

## Package Outline Dimensions

Please see AP02002 at <http://www.diodes.com/datasheets/ap02002.pdf> for the latest version.

### SOD323

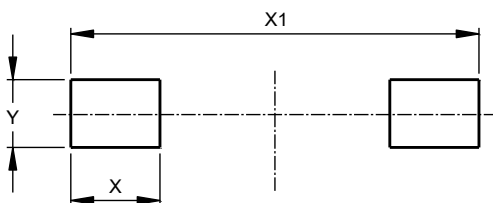


SOD323			
Dim	Min	Max	Typ
A1	--	0.10	0.05
A2	1.00	1.10	1.05
b	0.25	0.35	0.30
c	0.10	0.15	0.11
D	1.20	1.40	1.30
E	1.60	1.80	1.70
He	2.30	2.70	2.50
L	0.20	0.40	0.30
a	0°	8°	--
All Dimensions in mm			

## Suggested Pad Layout

Please see AP02001 at <http://www.diodes.com/datasheets/ap02001.pdf> for the latest version.

### SOD323



Dimensions	Value (in mm)
X	0.590
X1	2.700
Y	0.450

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